

N-Channel 60 V(D-S) MOSFET

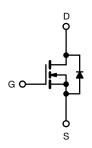
PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.072				
Q _g max. (nC)	25				
Q _{gs} (nC)	5.8				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- Dynamic dV/dt rating
- Fast switching
- Ease of paralleling Simple drive requirements







N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	60	V	
Gate-Source Voltage			V_{GS}	± 20	V	
Continuous Drain Current	V at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I _D	20	А	
	V _{GS} at 10 V	T _C = 100 °C		12		
Pulsed Drain Current ^a			I _{DM}	68		
Linear Derating Factor				0.40	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	100	mJ	
Maximum Power Dissipation $T_C = 25 ^{\circ}C$			P_{D}	60	W	
Peak Diode Recovery dV/dt ^c			dV/dt	4.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C	
Soldering Recommendations (Peak temperature) ^d	for	10 s		300	-0	
Manatina Tanana	0.00	0.00 140		10	lbf ⋅ in	
Mounting Torque	6-32 or M3 screw			1.1	N⋅m	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 403 μ H, R_g = 25 Ω , I_{AS} = 17 A (see fig. 12).
- c. $I_{SD} \leq 17$ A, $dI/dt \leq 140$ A/µs, $V_{DD} \leq V_{DS}$, $T_{J} \leq 175$ °C.
- d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	62			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	2.5			

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				1	1		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.061	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		-	3.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V		-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 60 V, V _{GS} = 0 V , V _{GS} = 0 V, T _J = 150 °C	-	-	25 250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 10 A ^b	-	0.072	-	Ω
Forward Transconductance	9 _{fs}	V_{DS}	= 25 V, I _D = 10 A	5.5	-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,		640	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 \text{ V},$	-	360	-	pF
Reverse Transfer Capacitance	C_{rss}	f = 1.	.0 MHz, see fig. 5	-	79	-	
Total Gate Charge	Q_g			-	-	25	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	$I_D = 17 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	5.8	nC
Gate-Drain Charge	Q _{gd}	1	goo ng. o ana ro		-	11	
Turn-On Delay Time	t _{d(on)}	V_{DD} = 30 V, I_{D} = 17 A, R_{g} = 18 Ω , R_{D} = 1.7 Ω , see fig. 10 b		-	13	-	ns
Rise Time	t _r			-	58	-	
Turn-Off Delay Time	t _{d(off)}			-	25		
Fall Time	t _f			-	42	-	
Internal Drain Inductance	L _D	6 mm (0.25") t	Between lead, 6 mm (0.25") from		4.5	-	الم
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s				•		
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20	А
Pulsed Diode Forward Current ^a	I _{SM}			-	-	68	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 17 \text{A}, V_{GS} = 0 \text{V}^{ \text{b}}$		-	-	1.5	V
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = 17 A, dl/dt = 100 A/μs		-	88	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.29	0.64	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is do	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s$; duty cycle $\leq 2~\%$.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

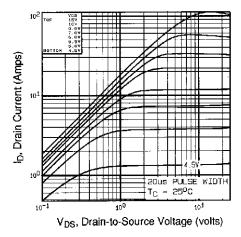


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

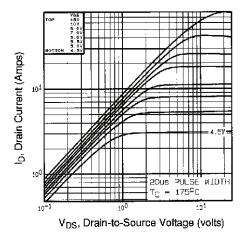


Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C

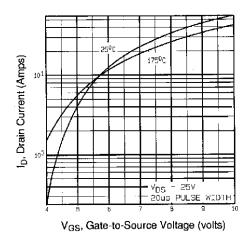


Fig. 3 - Typical Transfer Characteristics

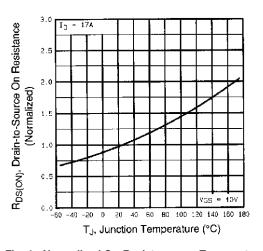


Fig. 4 - Normalized On-Resistance vs. Temperature

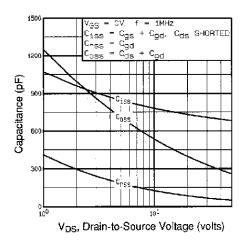


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

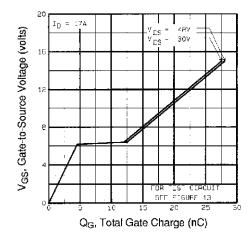


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



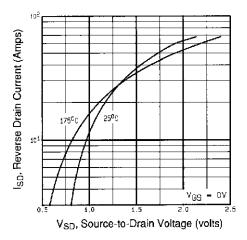


Fig. 7 - Typical Source-Drain Diode Forward Voltage

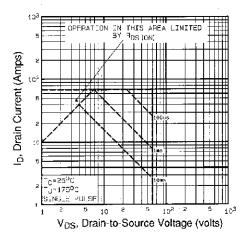


Fig. 8 - Maximum Safe Operating Area

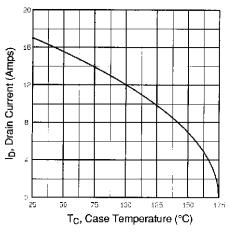


Fig. 9 - Maximum Drain Current vs. Case Temperature

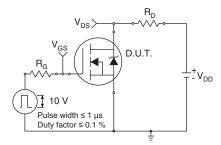


Fig. 10a - Switching Time Test Circuit

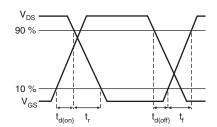


Fig. 10b - Switching Time Waveforms

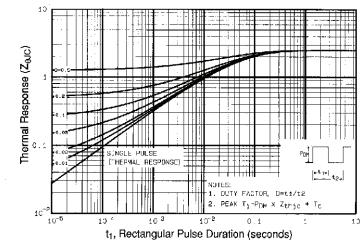
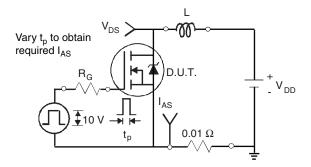


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case





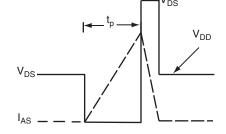


Fig. 12a - Unclamped Inductive Test Circuit

Fig. 12b - Unclamped Inductive Waveforms

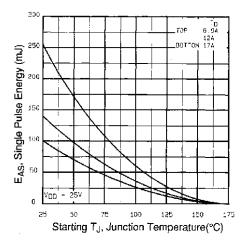


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

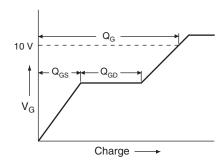


Fig. 13a - Basic Gate Charge Waveform

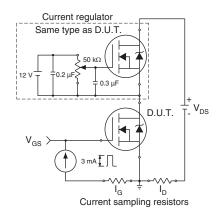
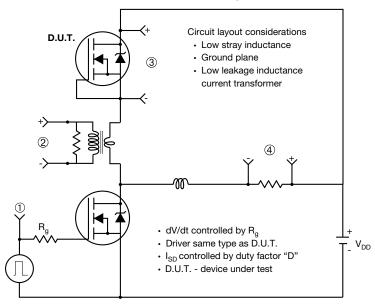


Fig. 13b - Gate Charge Test



Peak Diode Recovery dV/dt Test Circuit



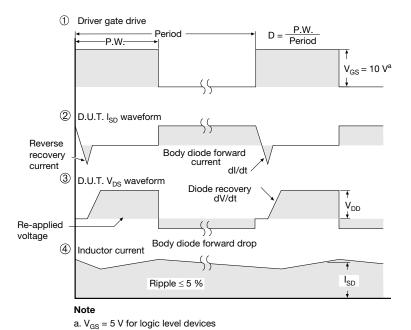
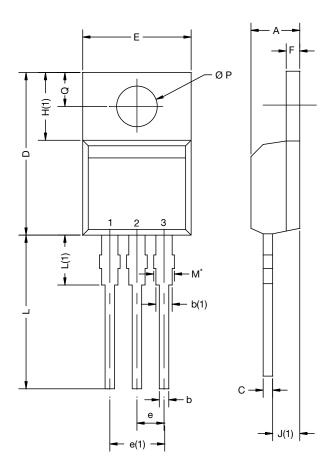


Fig. 14 - For N-Channel



TO-220



DIM	MILLIN	IETERS	INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
А	4.24	4.65	0.167	0.183		
b	0.69	1.02	0.027	0.040		
b(1)	1.14	1.78	0.045	0.070		
С	0.36	0.61	0.014	0.024		
D	14.33	15.85	0.564	0.624		
Е	9.96	10.52	0.392	0.414		
е	2.41	2.67	0.095	0.105		
e(1)	4.88	5.28	0.192	0.208		
F	1.14	1.40	0.045	0.055		
H(1)	6.10	6.71	0.240	0.264		
J(1)	2.41	2.92	0.095	0.115		
L	13.36	14.40	0.526	0.567		
L(1)	3.33	4.04	0.131	0.159		
ØΡ	3.53	3.94	0.139	0.155		
Q	2.54	3.00	0.100	0.118		
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031						

Note

 $\bullet~M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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